

FD-4030-15A-(C1~C5)-C

Features / Applications:

- OverCurrent Protection: Protect batteries from abnormal overcurrent behavior.
- OverVoltage Protection: Protect batteries from abnormal overvoltage behavior.
- Surface mountable fuse
- Halogen free
- Fast response time
- UL certificated: E314624 / TUV file number: TA50201483

Electrical Specifications:

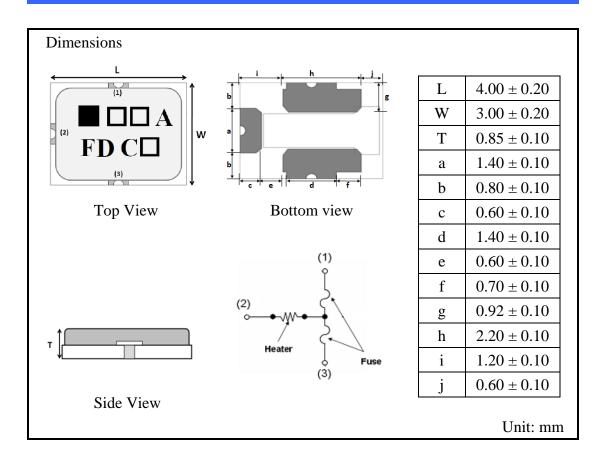
Characteristics	Feature		
Rated Voltage(*1)	36VDC		
Rated Breaking Capacity	50A		
Re-flow Temp.(MAX)	260°C		
Fuse Resistance(Typical)	1~3mΩ		
	C1: 0.63~1.35Ω		
Heater Resistance	C2: 2.2~3.3Ω		
	C3: 5.5~8.4Ω		
	C4: 10.4~15.8Ω		
	C5: 17.9~29.1Ω		
	C1: 3.00~4.50V		
Operating Voltage	C2: 5.00~9.00V		
	C3: 7.40~13.80V		
	C4: 10.50~19.60V		
	C5: 14.40~23.50V		

Note:

1. Maximum voltage is not the operating voltage for the heater.



Outline Drawing:



Type Designation:

FD	-	4030	-	15A	-	$C\Box$	-	C
(1)		(2)		(2)		(4)		(5)

(1) (2) (3) (4) (5)

Note:

(1) FD: Series number

(2) 4030 : 4.0 mm * 3.0 mm size

(3) 15A: Rated current

(4) C□: Cells

C1: One cell

C2: Two cells

C3: Three cells

C4: Four cells

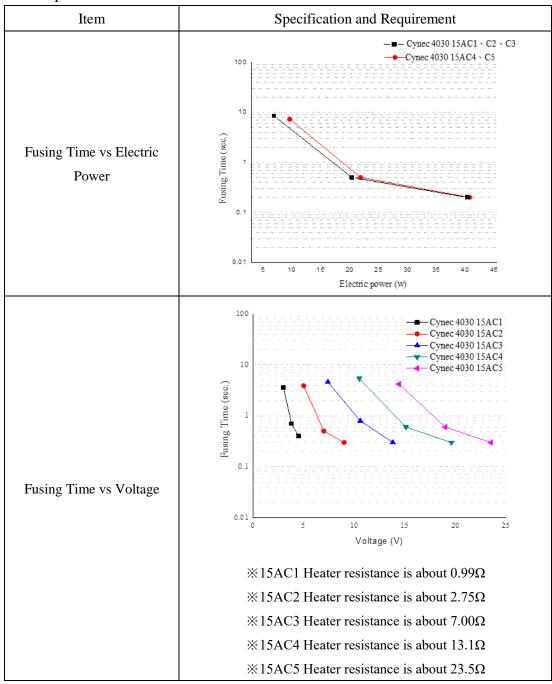
C5: Five cells

(5) C: C version



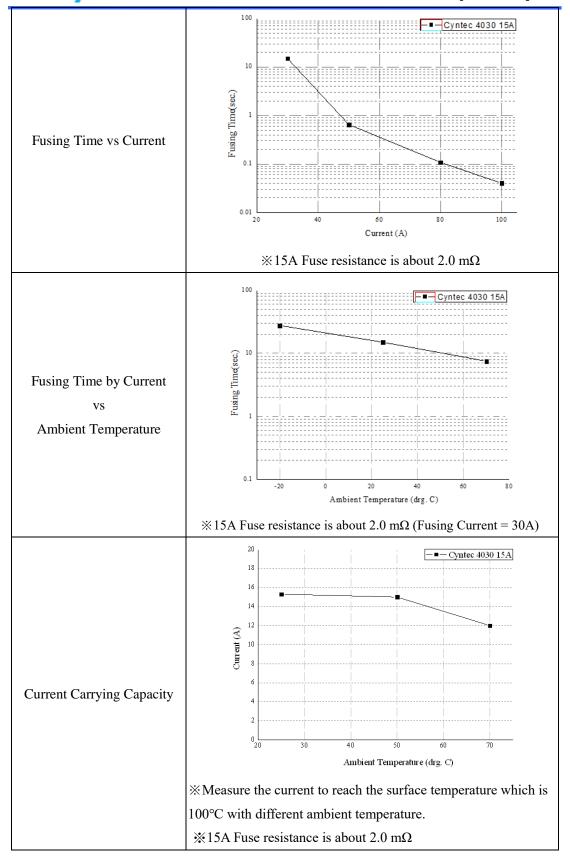
Characteristics:

Electric performance



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Reliability

Test Item	Condition of Test	Requirements	
Carrying capacity (UL248-14)	100% of rated current, 4hr	Without melting	
Temperature Rise (UL248-14)	100% of rated current, measure of surface temperature.	$\Delta T < 75$ °C	
Fusing time	200% rated current. Operating voltage shall be applied to heater.	Clearing time < 1 min	
Interrupting Ability	After the fuse is interrupted, rated voltage applied for 30sec again.	No mechanical damages	
Residual Resistance (UL248-14)	Measure DC resistance after fusing.	> 0.1MΩ	
Solderability (JEDEC J-STD-020D)	Temperature of Solder: 245 ± 5 °C Immersion Duration: 3 ± 0.5 second Refer to JIS C 5201-1 4.17	Uniform coating of solder cover minimum of 95% surface being immersed	
High Temperature Exposure (JESD22-A103C)	Kept at 100°C for 500 hours.	ΔR: ± 10% Without distinct damage in appearance	
Thermal Shock (JESD22-A104C)	l-55°C/25°C/125°C/25°C. 100 cycles.		
Current Rush Withstand 80A-10ms-On, 9990ms-Off, 500cycle.		No fusing	

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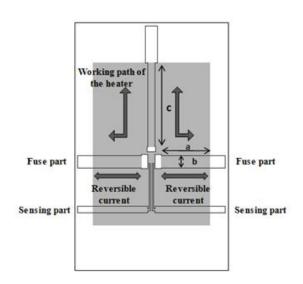


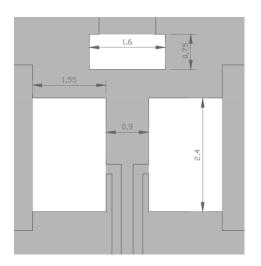
Recommended Solder Pad Dimensions:

The printed circuit board thickness is 0.6mm.

The thickness of tin plated copper layers is 2oz.

Recommended thickness of solder printing board is 0.12 mm at least.





Type	a	ь	С	
15A	8.0	3.5	14	

Unit: mm

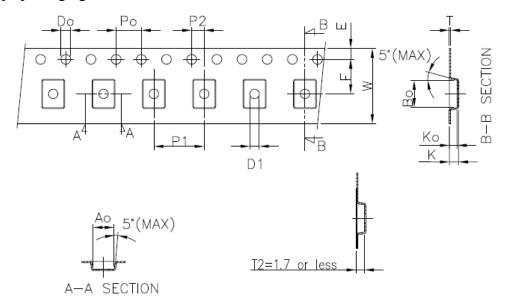


Chip setting



Packaging:

Tape packaging dimensions

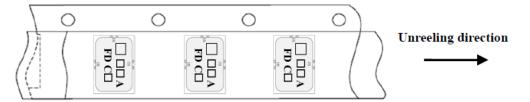


UNIT:mm

symbol	Ao	Во	Ko	Ро	P1	P2	Т
spec	3.50±0.10	4.50±0.10	1.25±0.10	4.00±0.10	8.00±0.10	2.00±0.05	0.30±0.10
symbol	Е	F	Do	D1	W	10Po	K
spec	1.75±0.10	5.50±0.05	1.55±0.05	1.50±0.10	12.0±0.30	40.0±0.20	1.60 or less

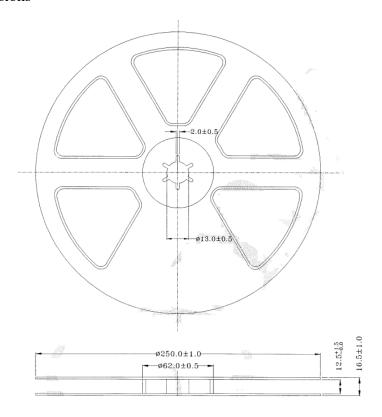
Direction

The direction shall be seen from the top cover tape side.





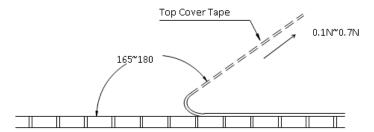
Reel dimensions



Number of Taping: 2,000 pieces/reel

Peel strength of top cover tape:

The peel speed shall be about 300mm/min.



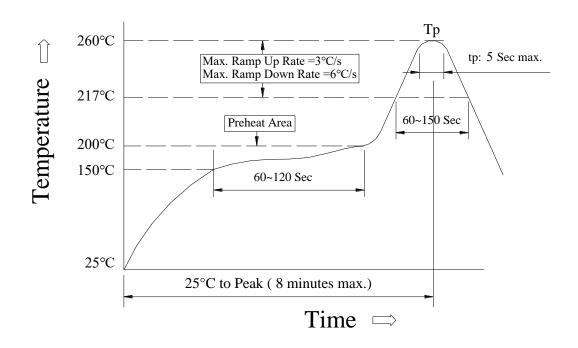
Label Marking:

The following items shall be marked on the reel:

- 1. Type designation
- 2. Quantity
- 3. Manufacturing date code
- 4. Manufacturer's name
- 5. The country of origin



Sn plating Reflow Profile:



Reflow Soldering Method:

D 0 0 11 '	Tp: 255~260°C	Max. 5 seconds	
Reflow Soldering	217°C	60~150 seconds	
Pre-Heat	150~200°C	60~120 seconds	
Time 25°C to peak temperature	8 minutes max.		

Note: Meet JEDEC J-STD-020D

Characteristics:

Functional temperature range: -25~85°C

Operating temperature range: -10~65°C (Fusing time <1min)

Test temperature range: 25 ± 5 °C

Ambient condition

Relative humidity: 45~85% Air Pressure: 86~106kPa

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Other Information:

Soldering iron method

Bit temperature: 300 ± 5 °C

Application of soldering iron: 3 seconds MAX

Apply the soldering iron to the electrode.

The specimen shall be stored at standard atmospheric condition for 24h, after which the measurements shall be made. Do not suggest products for re-work.

Product storage conditions

This product should be dark and at ambient temperature is less than 40°C or relative humidity less than 60% RH place, in the above storage conditions the storage period of 6 months.

Precautions on use

Avoid contact with the resin film with this product, its resin may seep into the product, so the product does not apply to the resin material relevance, its properties can't be fully guaranteed.